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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Active
Core Processor	PowerPC G2_LE
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	300MHz
Co-Processors/DSP	Communications; RISC CPM
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (2)
SATA	-
USB	USB 2.0 (1)
Voltage - I/O	3.3V
Operating Temperature	0°C ~ 105°C (TA)
Security Features	-
Package / Case	516-BBGA
Supplier Device Package	516-PBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mpc8247vrpiea

1 Overview

This table shows the functionality supported by each SoC in the MPC8272 family.

Table 1. MPC8272 PowerQUICC II Family Functionality

Functionality	SoCs			
	MPC8272	MPC8248	MPC8271	MPC8247
Package[1]	516 PBGA			
Serial communications controllers (SCCs)	3	3	3	3
QUICC multi-channel controller (QMC)	Yes	Yes	Yes	Yes
Fast communication controllers (FCCs)	2	2	2	2
I-Cache (Kbyte)	16	16	16	16
D-Cache (Kbyte)	16	16	16	16
Ethernet (10/100)	2	2	2	2
UTOPIA II Ports	1	0	1	0
Multi-channel controllers (MCCs)	0	0	0	0
PCI bridge	Yes	Yes	Yes	Yes
Transmission convergence (TC) layer	—	—	—	—
Inverse multiplexing for ATM (IMA)	—	—	—	—
Universal serial bus (USB) 2.0 full/low rate	1	1	1	1
Security engine (SEC)	Yes	Yes	—	—

[1] See Table 2.

Devices in the MPC8272 family are available in two packages—the VR or ZQ package—as shown in . For package ordering information, see Section 10, “Ordering Information.”

Table 2. MPC8272 PowerQUICC II Device Packages

Code (Package)	VR (516 PBGA—Lead free)	ZQ (516 PBGA—Lead spheres)
Device	MPC8272VR	MPC8272ZQ
	MPC8248VR	MPC8248ZQ
	MPC8271VR	MPC8271ZQ
	MPC8247VR	MPC8247ZQ

- Integrated security engine (SEC) (MPC8272 and MPC8248 only)
  - Supports DES, 3DES, MD-5, SHA-1, AES, PKEU, RNG and RC-4 encryption algorithms in hardware
- Communications processor module (CPM)
  - Embedded 32-bit communications processor (CP) uses a RISC architecture for flexible support for communications peripherals
  - Interfaces to G2_LE core through on-chip dual-port RAM and DMA controller. (Dual-port RAM size is 16 KB plus 4 KB dedicated instruction RAM.)
  - Microcode tracing capabilities
  - Eight CPM trap registers
- Universal serial bus (USB) controller
  - Supports USB 2.0 full/low rate compatible
  - USB host mode
    - Supports control, bulk, interrupt, and isochronous data transfers
    - CRC16 generation and checking
    - NRZI encoding/decoding with bit stuffing
    - Supports both 12- and 1.5-Mbps data rates (automatic generation of preamble token and data rate configuration). Note that low-speed operation requires an external hub.
    - Flexible data buffers with multiple buffers per frame
    - Supports local loopback mode for diagnostics (12 Mbps only)
  - Supports USB slave mode
    - Four independent endpoints support control, bulk, interrupt, and isochronous data transfers
    - CRC16 generation and checking
    - CRC5 checking
    - NRZI encoding/decoding with bit stuffing
    - 12- or 1.5-Mbps data rate
    - Flexible data buffers with multiple buffers per frame
    - Automatic retransmission upon transmit error
  - Serial DMA channels for receive and transmit on all serial channels
  - Parallel I/O registers with open-drain and interrupt capability
  - Virtual DMA functionality executing memory-to-memory and memory-to-I/O transfers
  - Two fast communication controllers (FCCs) supporting the following protocols:
    - 10-/100-Mbit Ethernet/IEEE 802.3 CDMA/CS interface through media independent interface (MII)
    - Transparent
    - HDLC—up to T3 rates (clear channel)

Table 5. DC Electrical Characteristics[1] (continued)

Characteristic	Symbol	Min	Max	Unit
I_{OL} = 6.0mA BR BG/IRQ6 ABB/IRQ2 TS A[0-31] TT[0-4] TBST TSIZE[0–3] AACK ARTRY DBG/IRQ7 DBB/IRQ3 D[0–63] IRQ3/CKSTP_OUT/EXT_BR3 IRQ4/CORE_SRESET/EXT_BG3 IRQ5/TBEN/EXT_DBG3/CINT PSDVAL TA TEA GBL/IRQ1 CI/BADDR29/IRQ2 WT/BADDR30/IRQ3 BADDR31/IRQ5/CINT CPU_BR/INT_OUT IRQ0/NMI_OUT PORESET/PCI_RST HRESET SRESET RSTCONF	V_{OL}	—	0.4	V

4.7 References

Semiconductor Equipment and Materials International(415) 964-5111
805 East Middlefield Rd.
Mountain View, CA 94043

MIL-SPEC and EIA/JESD (JEDEC) Specifications800-854-7179 or
(Available from Global Engineering Documents)303-397-7956

JEDEC Specifications http://www.jedec.org

1. C.E. Triplett and B. Joiner, “An Experimental Characterization of a 272 PBGA Within an Automotive Engine Controller Module,” Proceedings of SemiTherm, San Diego, 1998, pp. 47–54.
2. B. Joiner and V. Adams, “Measurement and Simulation of Junction to Board Thermal Resistance and Its Application in Thermal Modeling,” Proceedings of SemiTherm, San Diego, 1999, pp. 212–220.

5 Power Dissipation

This table provides preliminary, estimated power dissipation for various configurations. Note that suitable thermal management is required to ensure the junction temperature does not exceed the maximum specified value. Also note that the I/O power should be included when determining whether to use a heat sink. For a complete list of possible clock configurations, see Section 7, “Clock Configuration Modes.”

Table 8. Estimated Power Dissipation for Various Configurations[1]

Bus (MHz)	CPM Multiplication Factor	CPM (MHz)	CPU Multiplication Factor	CPU (MHz)	P_{INT}(W)[2,3]	
					Vddl 1.5 Volts	
					Nominal	Maximum
66.67	3	200	4	266	1	1.2
100	2	200	3	300	1.1	1.3
100	2	200	4	400	1.3	1.5
133	2	267	3	400	1.5	1.8

1 Test temperature = 105° C
2 $P_{INT} = I_{DD} \times V_{DD}$ Watts
3 Values do not include I/O. Add the following estimates for active I/O based on the following bus speeds:
66.7 MHz = 0.35 W (nominal), 0.4 W (maximum)
83.3 MHz = 0.4 W (nominal), 0.5 W (maximum)
100 MHz = 0.5 W (nominal), 0.6 W (maximum)
133 MHz = 0.7 W (nominal), 0.8 W (maximum)

This table lists CPM input characteristics.

NOTE: Rise/Fall Time on CPM Input Pins

It is recommended that the rise/fall time on CPM input pins should not exceed 5 ns. This should be enforced especially on clock signals. Rise time refers to signal transitions from 10% to 90% of VCC; fall time refers to transitions from 90% to 10% of VCC.

Table 11. AC Characteristics for CPM Inputs[1]

Spec Number		Characteristic	Value (ns)							
			Setup				Hold			
Setup	Hold		66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp16a	sp17a	FCC inputs—internal clock (NMSI)	6	6	6	6	0	0	0	0
sp16b	sp17b	FCC inputs—external clock (NMSI)	2.5	2.5	2.5	2.5	2	2	2	2
sp18a	sp19a	SCC/SMC/SPI/I2C inputs—internal clock (NMSI)	6	6	6	6	0	0	0	0
sp18b	sp19b	SCC/SMC/SPI/I2C inputs—external clock (NMSI)	4	4	4	4	2	2	2	2
sp20	sp21	TDM inputs/SI	3	3	3	3	2.5	2.5	2.5	2.5
sp22	sp23	PIO/TIMER/IDMA inputs	8	8	8	8	0.5	0.5	0.5	0.5

1 Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

NOTE

Although the specifications generally reference the rising edge of the clock, the following AC timing diagrams also apply when the falling edge is the active edge.

This figure shows the FCC internal clock.

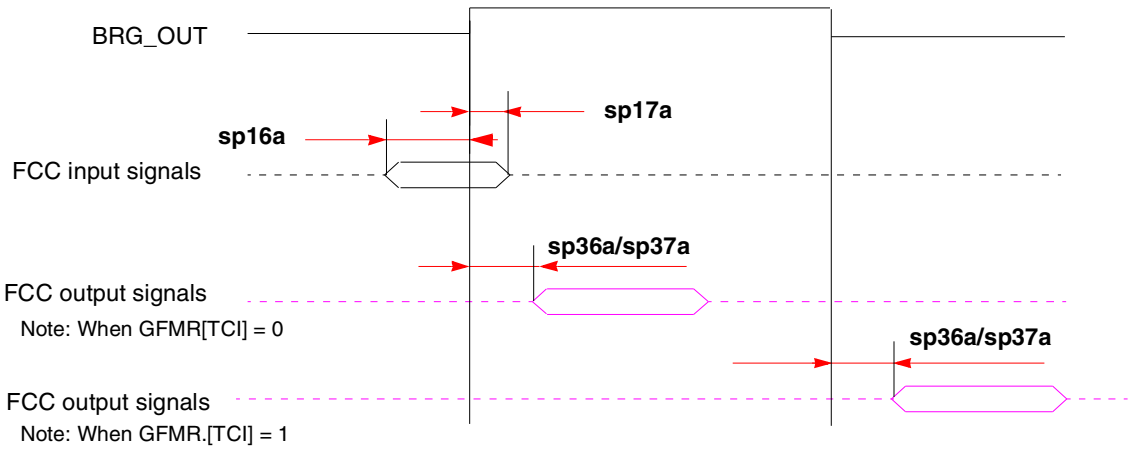


Figure 3. FCC Internal Clock Diagram

Table 17. Clock Configurations for PCI Host Mode (PCI_MODCK=0)[1,2]

Mode[3]	Bus Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		PCI Division Factor[6]	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0000_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0000_010	60.0	80.0	2.5	150.0	200.0	3	180.0	240.0	3	50.0	66.7
0000_011	60.0	80.0	2.5	150.0	200.0	3.5	210.0	280.0	3	50.0	66.7
0000_100	60.0	80.0	2.5	150.0	200.0	4	240.0	320.0	3	50.0	66.7
0000_101	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0000_110	50.0	66.7	3.5	150.0	200.0	3.5	175.0	233.3	3	50.0	66.7
0000_111	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
Full Configuration Modes											
0001_000	50.0	66.7	3	150.0	200.0	5	250.0	333.3	3	50.0	66.7
0001_001	50.0	66.7	3	150.0	200.0	6	300.0	400.0	3	50.0	66.7
0001_010	50.0	66.7	3	150.0	200.0	7	350.0	466.6	3	50.0	66.7
0001_011	50.0	66.7	3	150.0	200.0	8	400.0	533.3	3	50.0	66.7
0010_000	50.0	66.7	4	200.0	266.6	5	250.0	333.3	4	50.0	66.7
0010_001	50.0	66.7	4	200.0	266.6	6	300.0	400.0	4	50.0	66.7
0010_010	50.0	66.7	4	200.0	266.6	7	350.0	466.6	4	50.0	66.7
0010_011	50.0	66.7	4	200.0	266.6	8	400.0	533.3	4	50.0	66.7
0010_100	75.0	100.0	4	300.0	400.0	5	375.0	500.0	6	50.0	66.7
0010_101	75.0	100.0	4	300.0	400.0	5.5	412.5	549.9	6	50.0	66.7
0010_110	75.0	100.0	4	300.0	400.0	6	450.0	599.9	6	50.0	66.7
0011_000	50.0	66.7	5	250.0	333.3	5	250.0	333.3	5	50.0	66.7
0011_001	50.0	66.7	5	250.0	333.3	6	300.0	400.0	5	50.0	66.7
0011_010	50.0	66.7	5	250.0	333.3	7	350.0	466.6	5	50.0	66.7
0011_011	50.0	66.7	5	250.0	333.3	8	400.0	533.3	5	50.0	66.7
0100_000	Reserved										

Table 17. Clock Configurations for PCI Host Mode (PCI_MODCK=0)[1,2] (continued)

Mode[3]	Bus Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		PCI Division Factor[6]	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
0100_001	50.0	66.7	6	300.0	400.0	6	300.0	400.0	6	50.0	66.7
0100_010	50.0	66.7	6	300.0	400.0	7	350.0	466.6	6	50.0	66.7
0100_011	50.0	66.7	6	300.0	400.0	8	400.0	533.3	6	50.0	66.7
0101_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0101_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0101_010	50.0	66.7	2	100.0	133.3	3.5	175.0	233.3	2	50.0	66.7
0101_011	50.0	66.7	2	100.0	133.3	4	200.0	266.6	2	50.0	66.7
0101_100	50.0	66.7	2	100.0	133.3	4.5	225.0	300.0	2	50.0	66.7
0101_101	83.3	111.1	3	250.0	333.3	3.5	291.7	388.9	5	50.0	66.7
0101_110	83.3	111.1	3	250.0	333.3	4	333.3	444.4	5	50.0	66.7
0101_111	83.3	111.1	3	250.0	333.3	4.5	375.0	500.0	5	50.0	66.7
0110_000	60.0	80.0	2.5	150.0	200.0	2.5	150.0	200.0	3	50.0	66.7
0110_001	60.0	80.0	2.5	150.0	200.0	3	180.0	240.0	3	50.0	66.7
0110_010	60.0	80.0	2.5	150.0	200.0	3.5	210.0	280.0	3	50.0	66.7
0110_011	60.0	80.0	2.5	150.0	200.0	4	240.0	320.0	3	50.0	66.7
0110_100	60.0	80.0	2.5	150.0	200.0	4.5	270.0	360.0	3	50.0	66.7
0110_101	60.0	80.0	2.5	150.0	200.0	5	300.0	400.0	3	50.0	66.7
0110_110	60.0	80.0	2.5	150.0	200.0	6	360.0	480.0	3	50.0	66.7
0111_000	Reserved										
0111_001	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0111_010	50.0	66.7	3	150.0	200.0	3.5	175.0	233.3	3	50.0	66.7
0111_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0111_100	50.0	66.7	3	150.0	200.0	4.5	225.0	300.0	3	50.0	66.7
1000_000	Reserved										
1000_001	66.7	88.9	3	200.0	266.6	3	200.0	266.6	4	50.0	66.7

Table 17. Clock Configurations for PCI Host Mode (PCI_MODCK=0)[1,2] (continued)

Mode[3]	Bus Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		PCI Division Factor[6]	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1000_010	66.7	88.9	3	200.0	266.6	3.5	233.3	311.1	4	50.0	66.7
1000_011	66.7	88.9	3	200.0	266.6	4	266.7	355.5	4	50.0	66.7
1000_100	66.7	88.9	3	200.0	266.6	4.5	300.0	400.0	4	50.0	66.7
1000_101	66.7	88.9	3	200.0	266.6	6	400.0	533.3	4	50.0	66.7
1000_110	66.7	88.9	3	200.0	266.6	6.5	433.3	577.7	4	50.0	66.7
1001_000	Reserved										
1001_001	Reserved										
1001_010	57.1	76.2	3.5	200.0	266.6	3.5	200.0	266.6	4	50.0	66.7
1001_011	57.1	76.2	3.5	200.0	266.6	4	228.6	304.7	4	50.0	66.7
1001_100	57.1	76.2	3.5	200.0	266.6	4.5	257.1	342.8	4	50.0	66.7
1001_101	85.7	114.3	3.5	300.0	400.0	5	428.6	571.4	6	50.0	66.7
1001_110	85.7	114.3	3.5	300.0	400.0	5.5	471.4	628.5	6	50.0	66.7
1001_111	85.7	114.3	3.5	300.0	400.0	6	514.3	685.6	6	50.0	66.7
1010_000	75.0	100.0	2	150.0	200.0	2	150.0	200.0	3	50.0	66.7
1010_001	75.0	100.0	2	150.0	200.0	2.5	187.5	250.0	3	50.0	66.7
1010_010	75.0	100.0	2	150.0	200.0	3	225.0	300.0	3	50.0	66.7
1010_011	75.0	100.0	2	150.0	200.0	3.5	262.5	350.0	3	50.0	66.7
1010_100	75.0	100.0	2	150.0	200.0	4	300.0	400.0	3	50.0	66.7
1010_101	100.0	133.3	2	200.0	266.6	2.5	250.0	333.3	4	50.0	66.7
1010_110	100.0	133.3	2	200.0	266.6	3	300.0	400.0	4	50.0	66.7
1010_111	100.0	133.3	2	200.0	266.6	3.5	350.0	466.6	4	50.0	66.7
1011_000	Reserved										
1011_001	80.0	106.7	2.5	200.0	266.6	2.5	200.0	266.6	4	50.0	66.7
1011_010	80.0	106.7	2.5	200.0	266.6	3	240.0	320.0	4	50.0	66.7
1011_011	80.0	106.7	2.5	200.0	266.6	3.5	280.0	373.3	4	50.0	66.7

Table 18. Clock Configurations for PCI Host Mode (PCI_MODCK=1)[1,2]

Mode[3]	Bus Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		PCI Division Factor[6]	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	60.0	100.0	2	120.0	200.0	2.5	150.0	250.0	4	30.0	50.0
0000_001	50.0	100.0	2	100.0	200.0	3	150.0	300.0	4	25.0	50.0
0000_010	60.0	120.0	2.5	150.0	300.0	3	180.0	360.0	6	25.0	50.0
0000_011	60.0	120.0	2.5	150.0	300.0	3.5	210.0	420.0	6	25.0	50.0
0000_100	60.0	120.0	2.5	150.0	300.0	4	240.0	480.0	6	25.0	50.0
0000_101	50.0	100.0	3	150.0	300.0	3	150.0	300.0	6	25.0	50.0
0000_110	50.0	100.0	3	150.0	300.0	3.5	175.0	350.0	6	25.0	50.0
0000_111	50.0	100.0	3	150.0	300.0	4	200.0	400.0	6	25.0	50.0
Full Configuration Modes											
0001_000	50.0	100.0	3	150.0	300.0	5	250.0	500.0	6	25.0	50.0
0001_001	50.0	100.0	3	150.0	300.0	6	300.0	600.0	6	25.0	50.0
0001_010	50.0	100.0	3	150.0	300.0	7	350.0	700.0	6	25.0	50.0
0001_011	50.0	100.0	3	150.0	300.0	8	400.0	800.0	6	25.0	50.0
0010_000	50.0	100.0	4	200.0	400.0	5	250.0	500.0	8	25.0	50.0
0010_001	50.0	100.0	4	200.0	400.0	6	300.0	600.0	8	25.0	50.0
0010_010	50.0	100.0	4	200.0	400.0	7	350.0	700.0	8	25.0	50.0
0010_011	50.0	100.0	4	200.0	400.0	8	400.0	800.0	8	25.0	50.0
0010_100	37.5	75.0	4	150.0	300.0	5	187.5	375.0	6	25.0	50.0
0010_101	37.5	75.0	4	150.0	300.0	5.5	206.3	412.5	6	25.0	50.0
0010_110	37.5	75.0	4	150.0	300.0	6	225.0	450.0	6	25.0	50.0
0011_000	30.0	50.0	5	150.0	250.0	5	150.0	250.0	5	30.0	50.0
0011_001	25.0	50.0	5	125.0	250.0	6	150.0	300.0	5	25.0	50.0
0011_010	25.0	50.0	5	125.0	250.0	7	175.0	350.0	5	25.0	50.0
0011_011	25.0	50.0	5	125.0	250.0	8	200.0	400.0	5	25.0	50.0
0100_000	Reserved										

Table 18. Clock Configurations for PCI Host Mode (PCI_MODCK=1)[1,2] (continued)

Mode[3]	Bus Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		PCI Division Factor[6]	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1000_010	66.7	133.3	3	200.0	400.0	3.5	233.3	466.7	8	25.0	50.0
1000_011	66.7	133.3	3	200.0	400.0	4	266.7	533.3	8	25.0	50.0
1000_100	66.7	133.3	3	200.0	400.0	4.5	300.0	600.0	8	25.0	50.0
1000_101	66.7	133.3	3	200.0	400.0	6	400.0	800.0	8	25.0	50.0
1000_110	66.7	133.3	3	200.0	400.0	6.5	433.3	866.7	8	25.0	50.0
1001_000	Reserved										
1001_001	Reserved										
1001_010	57.1	114.3	3.5	200.0	400.0	3.5	200.0	400.0	8	25.0	50.0
1001_011	57.1	114.3	3.5	200.0	400.0	4	228.6	457.1	8	25.0	50.0
1001_100	57.1	114.3	3.5	200.0	400.0	4.5	257.1	514.3	8	25.0	50.0
1001_101	42.9	85.7	3.5	150.0	300.0	5	214.3	428.6	6	25.0	50.0
1001_110	42.9	85.7	3.5	150.0	300.0	5.5	235.7	471.4	6	25.0	50.0
1001_111	42.9	85.7	3.5	150.0	300.0	6	257.1	514.3	6	25.0	50.0
1010_000	75.0	150.0	2	150.0	300.0	2	150.0	300.0	6	25.0	50.0
1010_001	75.0	150.0	2	150.0	300.0	2.5	187.5	375.0	6	25.0	50.0
1010_010	75.0	150.0	2	150.0	300.0	3	225.0	450.0	6	25.0	50.0
1010_011	75.0	150.0	2	150.0	300.0	3.5	262.5	525.0	6	25.0	50.0
1010_100	75.0	150.0	2	150.0	300.0	4	300.0	600.0	6	25.0	50.0
1010_101	100.0	200.0	2	200.0	400.0	2.5	250.0	500.0	8	25.0	50.0
1010_110	100.0	200.0	2	200.0	400.0	3	300.0	600.0	8	25.0	50.0
1010_111	100.0	200.0	2	200.0	400.0	3.5	350.0	700.0	8	25.0	50.0
1011_000	Reserved										
1011_001	80.0	160.0	2.5	200.0	400.0	2.5	200.0	400.0	8	25.0	50.0
1011_010	80.0	160.0	2.5	200.0	400.0	3	240.0	480.0	8	25.0	50.0
1011_011	80.0	160.0	2.5	200.0	400.0	3.5	280.0	560.0	8	25.0	50.0
1011_100	80.0	160.0	2.5	200.0	400.0	4	320.0	640.0	8	25.0	50.0

Table 19. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)[1,2] (continued)

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
0011_000	Reserved										
0011_001	Reserved										
0011_010	Reserved										
0011_011	Reserved										
0011_100	Reserved										
0100_000	Reserved										
0100_001	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0100_010	50.0	66.7	3	150.0	200.0	3.5	175.0	200.0	3	50.0	66.7
0100_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0100_100	50.0	66.7	3	150.0	200.0	4.5	225.0	300.0	3	50.0	66.7
0101_000	50.0	66.7	5	250.0	333.3	2.5	250.0	333.3	2.5	100.0	133.3
0101_001	50.0	66.7	5	250.0	333.3	3	300.0	400.0	2.5	100.0	133.3
0101_010	50.0	66.7	5	250.0	333.3	3.5	350.0	466.6	2.5	100.0	133.3
0101_011	50.0	66.7	5	250.0	333.3	4	400.0	533.3	2.5	100.0	133.3
0101_100	50.0	66.7	5	250.0	333.3	4.5	450.0	599.9	2.5	100.0	133.3
0101_101	50.0	66.7	5	250.0	333.3	5	500.0	666.6	2.5	100.0	133.3
0101_110	50.0	66.7	5	250.0	333.3	5.5	550.0	733.3	2.5	100.0	133.3
0110_000	Reserved										
0110_001	50.0	66.7	4	200.0	266.6	3	200.0	266.6	3	66.7	88.9
0110_010	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9
0110_011	50.0	66.7	4	200.0	266.6	4	266.7	355.5	3	66.7	88.9
0110_100	50.0	66.7	4	200.0	266.6	4.5	300.0	400.0	3	66.7	88.9
0111_000	50.0	66.7	3	150.0	200.0	2	150.0	200.0	2	75.0	100.0
0111_001	50.0	66.7	3	150.0	200.0	2.5	187.5	250.0	2	75.0	100.0
0111_010	50.0	66.7	3	150.0	200.0	3	225.0	300.0	2	75.0	100.0
0111_011	50.0	66.7	3	150.0	200.0	3.5	262.5	350.0	2	75.0	100.0

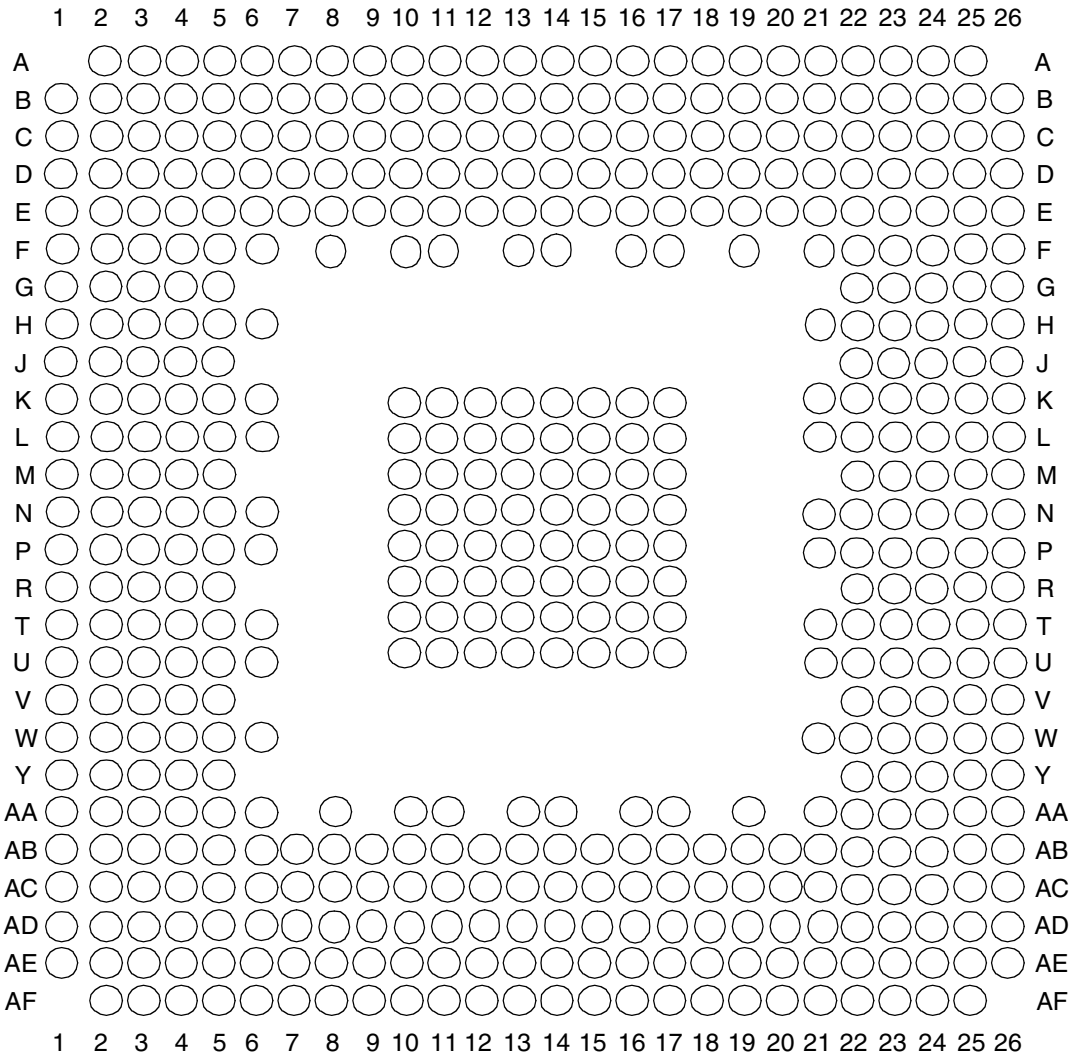
Table 20. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)[1,2]

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	30.0	50.0	4	120.0	200.0	2.5	150.0	250.0	2	60.0	100.0
0000_001	25.0	50.0	4	100.0	200.0	3	150.0	300.0	2	50.0	100.0
0000_010	25.0	50.0	6	150.0	300.0	3	150.0	300.0	3	50.0	100.0
0000_011	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0
0000_100	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
0000_101	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
0000_110	25.0	50.0	8	200.0	400.0	3.5	233.3	466.7	3	66.7	133.3
0000_111	25.0	50.0	8	200.0	400.0	3	240.0	480.0	2.5	80.0	160.0
Full Configuration Modes											
0001_001	30.0	50.0	4	120.0	200.0	5	150.0	250.0	4	30.0	50.0
0001_010	25.0	50.0	4	100.0	200.0	6	150.0	300.0	4	25.0	50.0
0001_011	25.0	50.0	4	100.0	200.0	7	175.0	350.0	4	25.0	50.0
0001_100	25.0	50.0	4	100.0	200.0	8	200.0	400.0	4	25.0	50.0
0010_001	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
0010_010	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
0010_011	25.0	50.0	6	150.0	300.0	4	240.0	480.0	2.5	60.0	120.0
0010_100	25.0	50.0	6	150.0	300.0	4.5	270.0	540.0	2.5	60.0	120.0
0011_000	Reserved										
0011_001	37.5	50.0	4	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0011_010	32.1	50.0	4	128.6	200.0	3.5	150.0	233.3	3	42.9	66.7
0011_011	28.1	50.0	4	112.5	200.0	4	150.0	266.7	3	37.5	66.7
0011_100	25.0	50.0	4	100.0	200.0	4.5	150.0	300.0	3	33.3	66.7
0100_000	Reserved										
0100_001	25.0	50.0	6	150.0	300.0	3	150.0	300.0	3	50.0	100.0
0100_010	25.0	50.0	6	150.0	300.0	3.5	175.0	350.0	3	50.0	100.0
0100_011	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0

Table 20. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)[1,2] (continued)

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
0100_100	25.0	50.0	6	150.0	300.0	4.5	225.0	450.0	3	50.0	100.0
0101_000	30.0	50.0	5	150.0	250.0	2.5	150.0	250.0	2.5	60.0	100.0
0101_001	25.0	50.0	5	125.0	250.0	3	150.0	300.0	2.5	50.0	100.0
0101_010	25.0	50.0	5	125.0	250.0	3.5	175.0	350.0	2.5	50.0	100.0
0101_011	25.0	50.0	5	125.0	250.0	4	200.0	400.0	2.5	50.0	100.0
0101_100	25.0	50.0	5	125.0	250.0	4.5	225.0	450.0	2.5	50.0	100.0
0101_101	25.0	50.0	5	125.0	250.0	5	250.0	500.0	2.5	50.0	100.0
0101_110	25.0	50.0	5	125.0	250.0	5.5	275.0	550.0	2.5	50.0	100.0
0110_000	Reserved										
0110_001	25.0	50.0	8	200.0	400.0	3	200.0	400.0	3	66.7	133.3
0110_010	25.0	50.0	8	200.0	400.0	3.5	233.3	466.7	3	66.7	133.3
0110_011	25.0	50.0	8	200.0	400.0	4	266.7	533.3	3	66.7	133.3
0110_100	25.0	50.0	8	200.0	400.0	4.5	300.0	600.0	3	66.7	133.3
0111_000	25.0	50.0	6	150.0	300.0	2	150.0	300.0	2	75.0	150.0
0111_001	25.0	50.0	6	150.0	300.0	2.5	187.5	375.0	2	75.0	150.0
0111_010	25.0	50.0	6	150.0	300.0	3	225.0	450.0	2	75.0	150.0
0111_011	25.0	50.0	6	150.0	300.0	3.5	262.5	525.0	2	75.0	150.0
1000_000	Reserved										
1000_001	25.0	50.0	6	150.0	300.0	2.5	150.0	300.0	2.5	60.0	120.0
1000_010	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
1000_011	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
1000_100	25.0	50.0	6	150.0	300.0	4	240.0	480.0	2.5	60.0	120.0
1000_101	25.0	50.0	6	150.0	300.0	4.5	270.0	540.0	2.5	60.0	120.0
1001_000	Reserved										
1001_001	Reserved										

This figure shows the pinout of the 516 PBGA package as viewed from the top surface.



Not to Scale

Figure 12. Pinout of the 516 PBGA Package (View from Top)

This table lists the pins of the MPC8272. Note that the pins in the “MPC8272/8271 Only” column relate to Utopia functionality.

Table 21. Pinout

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
$\overline{BR}$		A19
$\overline{BG}$/$\overline{IRQ6}$		D2
$\overline{ABB}$/$\overline{IRQ2}$		C1

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
$\overline{TS}$		D1
A0		A3
A1		B5
A2		D8
A3		C6
A4		A4
A5		A6
A6		B6
A7		C7
A8		B7
A9		A7
A10		D9
A11		E11
A12		C9
A13		B9
A14		D11
A15		A9
A16		B10
A17		A10
A18		B11
A19		A11
A20		D12
A21		A12
A22		D13
A23		B13
A24		C13
A25		C14
A26		B14
A27		D14
A28		E14
A29		A14

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
$\overline{\text{PCI\_IRDY}}$		AF15
$\overline{\text{PCI\_STOP}}$		AE15
$\overline{\text{PCI\_DEVSEL}}$		AE14
PCI_IDSEL		AC17
$\overline{\text{PCI\_PERR}}$		AD14
$\overline{\text{PCI\_SERR}}$		AD13
$\overline{\text{PCI\_REQ0}}$		AE20
$\overline{\text{PCI\_REQ1}}$/CPCI_HS_ES		AF14
$\overline{\text{PCI\_GNT0}}$		AD20
$\overline{\text{PCI\_GNT1}}$/CPCI_HS_LED		AE13
$\overline{\text{PCI\_GNT2}}$/$\overline{\text{CPCI\_HS\_ENUM}}$		AF21
$\overline{\text{PCI\_RST}}$		AF22
$\overline{\text{PCI\_INTA}}$		AE21
$\overline{\text{PCI\_REQ2}}$		AB14
DLLOUT		AC22
PCI_AD0		AF7
PCI_AD1		AE10
PCI_AD2		AB10
PCI_AD3		AD10
PCI_AD4		AE9
PCI_AD5		AF8
PCI_AD6		AC10
PCI_AD7		AE11
PCI_AD8		AB11
PCI_AD9		AF10
PCI_AD10		AF9
PCI_AD11		AB12
PCI_AD12		AC12
PCI_AD13		AD12
PCI_AD14		AF11
PCI_AD15		AB13

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	**MPC8272/MPC8271 Only**	
PA31/FCC1_MII_COL	$\overline{\text{FCC1\_UT\_TXENB}}$	G22[3]
PB18/FCC2_MII_HDLC_RXD3		T25[3]
PB19/FCC2_MII_HDLC_RXD2		P22[3]
PB20/FCC2_MII_HDLC_RMII_RXD1		L25[3]
PB21/FCC2_MII_HDLC_RMII_RXD0/FCC2_TRAN_RXD		J26[3]
PB22/FCC2_MII_HDLC_TXD0/FCC2_TRAN_TXD/ FCC2_RMII_TXD0		U23[3]
PB23/FCC2_MII_HDLC_TXD1/FCC2_RMII_TXD1		U26[3]
PB24/FCC2_MII_HDLC_TXD2/L1RSYNCB2		M24[3]
PB25/FCC2_MII_HDLC_TXD3/L1TSYNCB2		M23[3]
PB26/FCC2_MII_CRS/L1RXDB2		H24[3]
PB27/FCC2_MII_COL/L1TXDB2		E25[3]
PB28/FCC2_MII_RMII_RX_ER/$\overline{\text{FCC2\_RTS}}$/TXD1		D26[3]
PB29/FCC2_MII_RMII_TX_EN		K21[3]
PB30/FCC2_MII_RX_DV/FCC2_RMII_CRS_DV		D24[3]
PB31/FCC2_MII_TX_ER		E23[3]
PC0/$\overline{\text{DREQ3}}$/BRGO7/$\overline{\text{SMSYN1}}$/L1CLKOA2		AF23[3]
PC1/BRGO6/$\overline{\text{L1RQA2}}$		AD23[3]
PC4/SMRXD1/SI2_L1ST4/$\overline{\text{FCC2\_CD}}$		AB22[3]
PC5/SMTXD1/SI2_L1ST3/$\overline{\text{FCC2\_CTS}}$		AE24[3]
PC6/$\overline{\text{FCC1\_CD}}$/SI2_L1ST2	FCC1_UT_RXADDR2	AF24[3]
PC7/$\overline{\text{FCC1\_CTS}}$	FCC1_UT_TXADDR2	AE26[3]
PC8/$\overline{\text{CD4}}$/RTS1/SI2_L1ST2/$\overline{\text{CTS3}}$		AC24[3]
PC9/$\overline{\text{CTS4}}$/L1TSYNCA2		AA23[3]
PC10/$\overline{\text{CD3}}$/USB_RN		AB25[3]
PC11/$\overline{\text{CTS3}}$/USB_RP/L1TXD3A2		V22[3]
PC12	FCC1_UT_RXADDR1	AA26[3]
PC13/BRGO5	FCC1_UT_TXADDR1	V23[3]
PC14/$\overline{\text{CD1}}$	FCC1_UT_RXADDR0	W24[3]
PC15/$\overline{\text{CTS1}}$	FCC1_UT_TXADDR0	U24[3]
PC16/CLK16		T23[3]

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
PC17/CLK15/BRGO8/$\overline{\text{DONE2}}$		T26[3]
PC18/CLK14/$\overline{\text{TGATE2}}$		R26[3]
PC19/CLK13/BRGO7/$\overline{\text{TGATE1}}$		P24[3]
PC20/CLK12/$\overline{\text{USBOE}}$		L26[3]
PC21/CLK11/BRGO6/CP_INT		L24[3]
PC22/CLK10/$\overline{\text{DONE3}}$	FCC1_UT_TXPRTY	L23[3]
PC23/CLK9/BRGO5/$\overline{\text{DACK3}}$/$\overline{\text{CD1}}$		K24[3]
PC24/CLK8/TIN3/$\overline{\text{TOUT4}}$/DREQ2/BRGO1		K23[3]
PC25/CLK7/BRGO4/$\overline{\text{DACK2}}$/SPISEL		F26[3]
PC26/CLK6/$\overline{\text{TOUT3}}$/TMCLK		H23[3]
PC27/CLK5/BRGO3/$\overline{\text{TOUT1}}$	FCC1_UT_RXPRTY	K22[3]
PC28/CLK4/TIN1/$\overline{\text{TOUT2}}$/SPICLK		D25[3]
PC29/CLK3/TIN2/BRGO2/$\overline{\text{CTS1}}$		F24[3]
PD7/SMSYN2	FCC1_UT_TXADDR3	AB21[3]
PD14/I2CSCL		AC26[3]
PD15/I2CSDA		Y23[3]
PD16/SPIMISO	FCC1_UT_TXPRTY	AA25[3]
PD17/BRGO2/SPIMOSI	FCC1_UT_RXPRTY	Y26[3]
PD18/SPICLK	FCC1_UT_RXADDR4	W25[3]
PD19/SPISEL/BRGO1	FCC1_UT_TXADDR4	V25[3]
PD20/$\overline{\text{RTS4}}$/L1RSYNCA2		R24[3]
PD21/TXD4/L1RXD0A2		P23[3]
PD22/RXD4/L1TXD0A2		N25[3]
PD23/$\overline{\text{RTS3}}$/USB_TP		K26[3]
PD24/TXD3/USB_TN		K25[3]
PD25/RXD3/USB_RXD		J25[3]
PD29/$\overline{\text{RTS1}}$	FCC1_UT_RXADDR3	C26[3]
PD30/TXD1		E24[3]
PD31/RXD1		B25[3]
VCCSYN		C18
VCCSYN1		K6

9 Package Description

This figure shows the side profile of the PBGA package to indicate the direction of the top surface view.

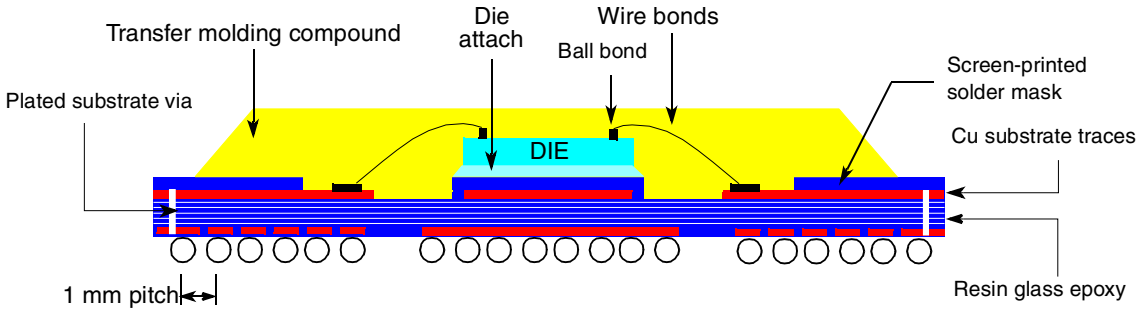


Figure 13. Side View of the PBGA Package Remove

9.1 Package Parameters

This table provides package parameters.

Table 22. Package Parameters

Code	Type	Outline (mm)	Interconnects	Pitch (mm)	Nominal Unmounted Height (mm)
VR, ZQ	PBGA	27 x 27	516	1	2.25

NOTE: Temperature Reflow for the VR Package

In the VR package, sphere composition is lead-free (see Table 2). This requires higher temperature reflow than what is required for other PowerQUICC II packages. Consult “Freescale PowerQUICC II Pb-Free Packaging Information” (MPC8250PBFREEPKG) available on www.freescale.com.

Table 23. Document Revision History (continued)

Revision	Date	Substantive Changes
0.2	12/2003	• Table 1: New • Table 2: New • Table 4: Modification of VDD and VCCSYN to 1.45–1.60 V • Table 8: Addition of note 2 regarding TRST and PORESET (see V_{IH} row of Table 8) • Table 8 and Table 21: Addition of muxed signals CPCI_HS_ES to PCI_REQ1 (AF14) CPCI_HS_LED to PCI_GNT1 (AE13) CPCI_HS_ENUM to PCI_GNT2 (AF21) • Table 8 and Table 21: Modification of PCI signal names for consistency with PCI signal names on other PowerQUICC II devices: PCI_CFG0 (PCI_HOST_EN) (AC21) PCI_CFG1 (PCI_ARB_EN) (AE22) PCI_CFG2 (DLL_ENABLE) (AE23) PCI_PAR (AF12) PCI_FRAME (AD15) PCI_TRDY(AF16) PCI_IRDY (AF15) PCI_STOP (AE15) DEVSEL (AE14) PCI_IDSEL (AC17) PCI_PERR (AD14) PCI_SERR (AD13) PCI_REQ0–2 (AAE20, AF14, AB14) PCI_GNT0–2 (AD20, AE13, AF21) PCI_RST (AF22) PCI_INTA (AE21) PCI_C0-3 (AE12, AF13, AC15, AE18) PCI_AD0-31 • Table 8 and Table 21: Corrected assertion level (added "‾") PCI_HOST_EN (AC21) and PCI_ARB_EN (AE22) • Table 7: Addition of $R_{\theta JT}$ and note 4 • Sections 4.1–4.5 and 4.7 on thermal characteristics: New • Section 7, "Clock Configuration Modes": Modification to first paragraph. Note that PCI_MODCK is a bit in the Hard Reset Configuration Word. It is not an input signal as it is in the MPC8280 Family and MPC8260 Family. • Addition of "Note: Temperature Reflow for the VR Package" on page 56 • Table 21: Addition of note 2 to TRST (E21) and PORESET (C24) • Table 21: Removal of Thermal0 (D19) and Thermal1(J3). These pins are now "No connects." Note 4 unchanged. • Table 21: Removal of Spare0 (AD24). This pin is now a "No connect." Note 5 unchanged. • Table 21: Addition of PCI_MODE (AD22). This pin was previously listed as "Ground." Addition of note 1.
0.1	9/2003	• Addition of the MPC8271 and the MPC8247 (these devices do not have a security engine) • Table 8: Addition of note 2 to V_{IH} • Table 8: Changed I_{OL} for 60x signals to 6.0 mA • Modification of note 1 for Table 17, Table 18, Table 19, and Table 20 • Table 21: Addition of ball AD9 to GND. In rev 0 of this document, AD8 was listed as assigned to both CS5 and GND. AD8 is only assigned to CS5. • Table 21: Addition of note 4 to Thermal0 (D19) and Thermal1(J3) • Addition of ZQ package code to Figure 15
0	5/2003	NDA release